### **Overview**

#### HP ProBook 430 G8 Notebook PC



- I. Internal Microphones (2)
- 2. Webcam LED (Optional)
- 3. HD and IR Camera (Optional)
- 4. Camera Shutter (Only available with webcam)
- IR Camera LED (Optional)

- 6. Clickpad
- 7. Micro SD Card Reader (Select Models)
- 8. Audio Combo Jack
- 9. SuperSpeed USB Type-A 5Gbps signaling rate port
- 10. Nano Security Lock Slot (Lock sold separately)

### Overview



#### Right

- 1. Power Button Key
- 2. Power Connector
- 3. SuperSpeed USB Type-C® 10Gbps signaling rate (USB Power Delivery, DisplayPort™ 1.4)
- 4. SuperSpeed USB Type-A 5Gbps signaling rate charging port
- 5. HDMI Port (Cable not included)
- 6. Touch Fingerprint Sensor (select models)

#### Overview

#### At a Glance

- A new compact design with lift-anywhere edge
- Choice of 11th generation Intel® Core™ i7, i5 and i3 processors
- Preinstalled with Windows 10 versions or FreeDOS
- Fast and upgradeable dual channel DDR4 SODIMM memory up to 32 GB
- Choice of 33.8 cm (13.3") diagonal HD, Ultra Wide Viewing Angle FHD, Touch or Non-Touch screen, and Privacy Panel
  option
- Features redesigned quiet and responsive HP Keyboard with the HP Programmable key and backlit options
- Choice of solid state drives up to 1 TB
- Multi-layered security with HP SureStart Gen6, HP Privacy Camera, HP Sure View Gen3<sup>1</sup>, HP Sure Sense, HP Sure Click and Touch Fingerprint reader<sup>2</sup>
- Supports wireless options for connectivity on the go including gigabit-speed Wi-Fi® 6
- Supports fast charging (50% in 30 minutes) with no impact on battery recharge cycles<sup>3</sup>
- Designed to support HP docking options
- Passed MIL-STD 810H tests<sup>4</sup>
- Battery life up to 12 hours and 45 minutes
- 1. HP Sure View integrated privacy screen is an optional feature that must be configured at purchase and is designed to function in landscape orientation.
- 2. Sold separately or as an optional feature
- 3.HP notebooks up to 50% within 30 minutes when the system is off or in standby mode. Power adapter with a minimum capacity of 65 watts is required. After charging has reached 50% capacity, charging will return to normal. Charging time may vary +/-10% due to System tolerance.
- 4. MIL STD 810H testing is not intended to demonstrate fitness for U.S. Department of Defense contract requirements or for military use. Test results are not a guarantee of future performance under these test conditions. Accidental damage requires an optional HP Accidental Damage Protection Care Pack.

**NOTE:** See important legal disclosures for all listed specs in their respective features sections.



### **Technical Specifications**

#### **PRODUCT NAME**

HP ProBook 430 G8 Notebook PC

#### **OPERATING SYSTEMS**

**Preinstalled** Windows 10 Pro 64 – HP recommends Windows 10 Pro for business<sup>1</sup>

Windows 10 Pro 64 (National Academic only)2

Windows 10 Home 641

Windows 10 Home Single Language 641

Windows 10 Pro (Windows 10 Enterprise available with a Volume Licensing Agreement)<sup>1</sup>

**FreeDOS** 

- 1. Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See http://www.windows.com.
- 2. Some devices for academic use will automatically be updated to Windows 10 Pro Education with the Windows 10 Anniversary Update. Features vary; see https://aka.ms/ProEducation for Windows 10 Pro Education feature information.

#### **Supported Versions**

HP tested Windows 10, version 1809 on this platform. For testing information on newer versions of Windows 10, please see https://support.hp.com/document/c05195282

#### **PROCESSORS**

Intel® Core™ i7-1185G7 (Up to 4.8 GHz with Intel® Turbo Boost Technology, 12 MB L3 cache, 4 cores) 3,45,6

Intel® Core™ i7-1165G7 (Up to 4.7 GHz with Intel® Turbo Boost Technology, 12 MB L3 cache, 4 cores) 3,45,6

Intel® Core™ i5-1145G7 (Up to 4.4 GHz with Intel® Turbo Boost Technology, 8 MB L3 cache, 4 cores) 3,45,6

Intel® Core™ i5-1135G7 (Up to 4.2 GHz with Intel® Turbo Boost Technology, 8 MB L3 cache, 4 cores) 3.45,6

Intel® Core™ i3-1125G4 with Intel® UHD Graphics (Up to 3.7 GHz with Intel® Turbo Boost Technology, 8 MB L3 cache, 4 cores) 3,45,6

Intel® Core™ i3-1115G4 with Intel® UHD Graphics (Up to 4.1 GHz with Intel® Turbo Boost Technology, 6 MB L3 cache, 2 cores) 3,45,6

Intel® Pentium® Gold 7505 with Intel® UHD Graphics (Up to 3.5 GHz with Intel® Turbo Boost Technology, 4 MB L3 cache, 2 cores) 3,45,6

Intel® Celeron® 6305 with Intel® UHD Graphics (1.8 GHz base frequency, 4 MB L3 cache, 2 cores) 3,45,6

#### **Processors Family**

11th Generation Intel® Core™ i7 processor (i7-1165G7)<sup>7</sup>

11th Generation Intel® Core™ i5 processor (i5-1135G7)<sup>7</sup>

11th Generation Intel® Core™ i3 processor (i3-1115G4)<sup>7</sup>

3. Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application



### **Technical Specifications**

workload and your hardware and software configurations. Intel's numbering, branding and/or naming is not a measurement of higher performance.

- 4. Processor speed denotes maximum performance mode; processors will run at lower speeds in battery optimization mode.
- 5. Intel® Turbo Boost performance varies depending on hardware, software and overall system configuration. See http://www.intel.com/technology/turboboost for more information.
- 6. Max Boost clock frequency performance varies depending on hardware, software and overall system configuration.
- 7. In accordance with Microsoft's support policy, HP does not support the Windows 8 or Windows 7 operating system on products configured with Intel and AMD 7th generation and forward processors or provide any Windows 8 or Windows 7 drivers on http://www.support.hp.com.

#### **CHIPSET**

Chipset is integrated with processor

#### **GRAPHICS**

#### Integrated

Intel® Iris® Xe Graphics (Core i5 and Core i7)<sup>35</sup> Intel® UHD Graphics (Core i3)<sup>8</sup>

#### Supports

Support HD decode, DX12, HDMI 1.4b

- 8. HD content required to view HD images.
- 35. Intel® Iris® Xe Graphics capabilities require system to be configured with Intel® Core™ i5 or i7 processors and dual channel memory. Intel® Iris® Xe Graphics with Intel® Core™ i5 or 7 processors and single channel memory will only function as UHD graphics.

#### **DISPLAYS**

#### Internal

#### Non-Touch

- 33.8 cm (13.3") diagonal HD SVA eDP anti-glare, narrow bezel, 250 nits, 45% NTSC (1366 x 768) 8,10
- 33.8 cm (13.3") diagonal HD SVA eDP anti-glare, narrow bezel, 250 nits, 45% NTSC for HD camera (1366 x 768)  $^{8,10}$
- 33.8 cm (13.3") diagonal HD SVA eDP anti-glare, narrow bezel, 250 nits, 45% NTSC for HD+IR camera (1366 x 768) 8,10
- 33.8 cm (13.3") diagonal FHD UWVA eDP anti-glare, narrow bezel flat, 250 nits, 45% NTSC for HD camera (1920 x 1080)<sup>8,10</sup>
- 33.8 cm (13.3") diagonal FHD UWVA eDP anti-glare, narrow bezel flat, 250 nits, 45% NTSC for HD+IR camera (1920 x 1080) 8,10
- 33.8 cm (13.3") diagonal FHD UWVA eDP+PSR anti-glare, low power narrow bezel flat, 400 nits, 72% NTSC for HD camera (1920 x 1080) 8,10
- 33.8 cm (13.3") diagonal FHD UWVA eDP+PSR anti-glare, low power narrow bezel flat, 400 nits, 72% NTSC for HD+IR camera (1920 x 1080) 8,10
- 33.8 cm (13.3") diagonal FHD UWVA eDP+PSR anti-glare, narrow bezel flat with HP Sure View Gen3 Integrated Privacy Screen, 1000 nits, 100% sRGB for HD camera (1920 x 1080) 8,10,11
- 33.8 cm (13.3") diagonal FHD UWVA eDP+PSR anti-glare narrow bezel flat with HP Sure View Gen3 Integrated Privacy Screen, 1000 nits, 100% sRGB for HD+IR camera (1920 x 1080)  $^{8,10,11}$



### **Technical Specifications**

#### **Touch**

33.8 cm (13.3") diagonal FHD UWVA eDP anti-glare, narrow bezel flat, touch-on-panel screen, 250 nits, 45% NTSC for HD camera (1366 x 768)  $^{8,9,10}$ 

#### **HDMI**

Supports resolutions up to 4K 30Hz

- 8. HD content required to view HD images.
- 9. Sold separately or as an optional feature.
- 10. Resolutions are dependent upon monitor capability, and resolution and color depth settings.
- 11. HP Sure View integrated privacy screen is an optional feature that must be configured at purchase and is designed to function in landscape orientation.

NOTE: Actual brightness will be lower with touchscreen or Sure View.

#### STORAGE AND DRIVES

#### Primary M.2 Storage

128 GB PCIe® NVMe™ M.2 TLC Solid State Drive <sup>12</sup>
256 GB PCIe® NVMe™ M.2 Value Solid State Drive <sup>12</sup>

512 GB PCIe<sup>®</sup> NVMe<sup>™</sup> M.2 Value Solid State Drive <sup>12</sup>

512 GB Intel® PCIe® NVMe™ QLC M.2 SSD with 32 GB Intel® Optane™ memory H10 12, 38,39

1 TB PCIe® NVMe™ M.2 TLC Solid State Drive 12

- 12. For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10) is reserved for system recovery software.
- 38. Intel® Optane™ memory system acceleration does not replace or increase the DRAM in your system. Requires 8th Gen or higher Intel® Core™ processor, BIOS version with Intel® Optane™ supported, Windows 10 64-bit, and an Intel® Rapid Storage Technology (Intel® RST) driver.
- 39. Intel® Optane™ memory H10 only for Intel® PCIe® NVMe™ QLC M.2 SSD.



### **Technical Specifications**

#### **MEMORY**

#### **Maximum Memory**

32 GB DDR4-3200 SDRAM 13

#### Memory

32 GB DDR4-3200 SDRAM (2 x 16 GB) <sup>13</sup>
16 GB DDR4-3200 SDRAM (1 x 16 GB) <sup>13</sup>
12 GB DDR4- 3200 SDRAM (4 GB and 8 GB (1 x 8 GB)) <sup>13</sup>
8 GB DDR4-3200 SDRAM (1 x 8 GB) <sup>13</sup>
8 GB DDR4-3200 SDRAM (2 x 4 GB) <sup>13</sup>
4 GB DDR4-3200 SDRAM (1 x 4 GB) <sup>13</sup>

#### **Memory Slots**

2 SODIMM
Both slots are accessible/upgradeable by IT or self-maintainers only
DDR4 PC4 SODIMMS, system runs at 3200
Supports Dual Channel Memory

13. Due to the non-industry standard nature of some third-party memory modules, we recommend HP branded memory to ensure compatibility. If you mix memory speeds, the system will perform at the lower memory speed.

#### **NETWORKING/COMMUNICATIONS**

#### **WLAN**

Realtek RTL8822CE 802.11ac 2x2 Wi-Fi and Bluetooth® 5.0 Combo <sup>14</sup> Intel® Dual Band Wireless-AC 9560 802.11a/b/g/n/ac (2x2) WLAN and Bluetooth® 5.0 Combo, non-vPro® <sup>14</sup> Intel® Dual Band Wi-Fi® 6 AX201 802.11a/b/g/n/ac/ax (2x2) WLAN and Bluetooth® 5.1 Combo, non-vPro® <sup>15</sup> Realtek RTL8852AE 802.11ax 2x2 Wi-Fi and Bluetooth® 5.2 <sup>15</sup>

- 14. Wireless access point and internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 5 (802.11 ac) is backwards compatible with prior 802.11 specs.
- 15. Wireless access point and Internet service required and sold separately. Availability of public wireless access points limited. The specifications for Wi-Fi® 6 (802.11ax WLAN) are draft specifications and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the notebook to communicate with other 802.11ax WLAN devices. Only available in countries where 802.11ax is supported.



## **Technical Specifications**

#### **AUDIO/MULTIMEDIA**

#### Audio

2 Integrated stereo speakers Integrated microphone (Dual Array)

#### **Speaker Power**

2W/4ohm Per speaker

#### Camera

720p HD Camera<sup>8</sup>
720p HD Camera+IR Camera <sup>8,9</sup>

- 8. HD content required to view HD images.
- 9. Sold separately or as an optional feature.

#### **KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS**

#### Keyboard

HP Premium Keyboard, spill resistant and optional Durakeys and backlit

#### **Pointing Device**

Clickpad with multi-touch gesture support

#### **Function Keys**

- F1 Display Switching
- F2 Blank or SureView On/Off
- F3 Brightness Down
- F4 Brightness Up
- F5 Audio Mute
- F6 Volume Down
- F7 Volume Up
- F8 Mic Mute
- F9 Blank or Backlit Toggle
- F10 Insert
- F11 Airplane Mode
- F12 Programmable Key
- Print Screen

Power Button (with LED)

#### **Hidden Function Keys**

- Fn+R Break
- Fn+S Sys Rq
- Fn+C Scroll Lock



### **Technical Specifications**

#### **SOFTWARE AND SECURITY**

## Preinstalled Software BIOS

HP BIOSphere Gen5 16

**HP Drive Lock & Automatic Drive Lock** 

**BIOS Update via Network** 

Power On Authentication

HP Secure Erase 18

Absolute Persistence Module 19

**HP LAN-Wireless Protection** 

**Pre-boot Authentication** 

#### **Software**

Xerox® DocuShare® 30 day free trial offer42

HP Connection Optimizer 17

**HP Image Assistant** 

**HP Hotkey Support** 

myHP

**HP Noise Cancellation Software** 

**HSA Fusion for Commercial** 

**HSA Telemetry for Commercial** 

**Touchpoint Customizer for Commercial** 

**HP Notifications** 

**HP Privacy Settings** 

**HP System Information** 

**HP Wireless Button Driver** 

**HP Power Manager** 

**HP Work Well** 

Buy Office (sold separately)

HP Smart Support 43

#### **Manageability Features**

HP Driver Packs (download) 20

HP Manageability Integration Kit Gen3 (download) 21

HP System Software Manager (SSM) (download)

HP BIOS Config Utility (BCU) (download)

**HP Client Catalog (download)** 

HP Client Management Script Library (download)

#### **Client Security Software**

HP Client Security Manager Gen7 22

Windows Defender 23

#### **Security Management**

**Pre-boot Authentication** 

USB enable/disable (via BIOS)

Power-on password (via BIOS)

Setup password (via BIOS)

HP Fingerprint Sensor 24



### **Technical Specifications**

Support for chassis padlocks and cable lock devices

HP Sure Click 26

HP Sure Sense 27

HP Sure Start Gen6 28

HP Sure Admin 29

TPM 2.0 Embedded Security Chip (Common Criteria EAL4+ Certified) (FIPS 140-2 Level 2 Certified) <sup>30</sup> HP Wolf Pro Security Edition<sup>44</sup>

16. HP BIOSphere Gen5 is available on select HP Pro and Elite PCs. See product specifications for details. Features may vary depending on the platform and configurations.

17. HP Connection Optimizer requires Windows 10.

18. HP Secure Erase For the methods outlined in the National Institute of Standards and Technology Special Publication 800-88 "Clear" sanitation method. HP Secure Erase does not support platforms with Intel® Optane™.

19. Absolute firmware module is shipped turned off and can only be activated with the purchase a license subscription and full activation of the software agent. License subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S. Certain conditions apply. For full details visit:

https://www.absolute.com/about/legal/agreements/absolute/

- 20. HP Driver Packs not preinstalled, however available for download at http://www.hp.com/go/clientmanagement.
- 21. HP Manageability Integration Kit can be downloaded from http://www.hp.com/go/clientmanagement.
- 22. HP Client Security Manager Gen6 requires Windows and is available on the select HP Pro and Elite PCs.
- 23. Windows Defender Opt in and internet connection required for updates.
- 24. HP Fingerprint sensor is an optional feature that must be configured at purchase.
- 25. Windows Defender Opt in and internet connection required for updates.
- 26. HP Sure Click requires Windows 10 Pro or Enterprise. See https://bit.ly/2PrLT6A\_SureClick for complete details.
- 27. HP Sure Sense requires Windows 10. Pro or Enterprise
- 28. HP Sure Start Gen6 is available on select HP PCs.
- 29. HP Sure Admin requires Windows 10, HP BIOS, HP Manageability Integration Kit from

http://www.hp.com/go/clientmanagement and HP Sure Admin Local Access Authenticator smartphone app from the Android or Apple store.

- 30. Firmware TPM is version 2.0.
- 42. Simply sign up and start using Xerox® DocuShare® Go. No credit card. No obligation. Data will become unavailable unless a subscription is entered before the end of the 30-day free trial period. See visit http://www.xerox.com/docusharego for details.
- 43. HP Smart Support is available to commercial customers through your HP Service Representative and HP Factory Configuration Services; or it can be downloaded at: http://www.hp.com/smart-support. HP Smart Support automatically collects the telemetry necessary upon initial boot of the product to deliver device-level configuration data and health insights.
- 44. HP Wolf Pro Security Edition (including HP Sure Click Pro and HP Sure Sense Pro) is available preloaded on select SKUs and, depending on the HP product purchased, includes a paid 1-year or 3-year license. The HP Wolf Pro Security Edition software is licensed under the license terms of the HP Wolf Security Software End-User license Agreement (EULA) that can be found at: https://support.hp.com/us-en/document/ish\_3875769-3873014-16 as that EULA is modified by the following: "7. Term. Unless otherwise terminated earlier pursuant to the terms contained in this EULA, the license for the HP Wolf Pro Security Edition (HP Sure Sense Pro and HP Sure Click Pro) is effective upon activation and will continue for either a twelve (12) month or thirty-six (36) month license term ("Initial Term"). At the end of the Initial Term you may either (a) purchase a renewal license for the HP Wolf Pro Security Edition from HP.com, HP Sales or an HP Channel Partner, or (b) continue using the standard versions of HP Sure Click and HP Sure Sense at no additional cost with no future software updates or HP Support.



### **Technical Specifications**

#### **POWER**

#### Power Supply 16

HP Smart 65 W External AC power adapter <sup>32</sup>
HP Smart 65 W EM External AC power adapter <sup>32</sup>
HP Smart 65 W USB Type-C® adapter <sup>32</sup>
HP Smart 45 W External AC power adapter <sup>32</sup>
HP Smart 45 W USB Type-C® adapter <sup>32</sup>

#### **Primary Battery**

HP Long Life 3-cell, 45 Wh Polymer 33, 45

#### **Power Cord**

3-wire plug - 1m <sup>32</sup> 2-wire plug - 1m <sup>32</sup>

#### **Battery life**

Up to 12 hours and 45 minutes (UMA graphics, Intel® 11th generation CPU and 3-cell 45 Wh battery)

#### **Battery Weight**

190 g

- 32. Availability may vary by country.
- 33. Battery is internal and not replaceable by customer. Serviceable by warranty.
- 45. Actual battery Watt-hours (Wh) will vary from design capacity. Battery capacity will naturally decrease with shelf life, time, usage, environment, temperature, system configuration, loaded apps, features, power management settings and other factors.

#### **WEIGHTS & DIMENSIONS**

#### Product Weight 34

Starting at 2.81 lb Starting at 1.28kg (400nits panel only)

#### Product Dimensions (w x d x h)

Metal bottom cover: 12.08 x 8.2 x 0.62 in 30.69 x 20.84 x 1.59 cm

Plastic bottom cover: 12.08 x 8.2 x 0.69 in 30.69 x 20.84 x 1.77 cm

34. Weight will vary by configuration.



### **Technical Specifications**

#### **PORTS/SLOTS**

#### **Ports**

1 SuperSpeed USB Type-C<sup>®</sup> 10Gbps signaling rate (USB Power Delivery, DisplayPort™ 1.4)

2 SuperSpeed USB Type-A 5Gbps signaling rate <sup>35</sup> (1 charging, 1 powered port)

1 HDMI 1.4b 36

1 Headphone/microphone combo jack

1 AC power

#### **Expansion Slots**

1 Micro SD Card Reader Supports SD, SDHC, SDXC

36. HDMI cable sold separately.

#### SERVICE AND SUPPORT

HP Services offers 3-year and 1-year limited warranties and 90-day software limited warranty options depending on country. Batteries have a default one-year limited warranty except for Long Life batteries which will have same 1-year or 3-year limited warranty as the platform. Refer to <a href="http://www.hp.com/support/batterywarranty/">http://www.hp.com/support/batterywarranty/</a> for additional battery information. On-site service and extended coverage is also available. HP Care Pack Services are optional extended service contracts that go beyond the standard limited warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: <a href="http://www.hp.com/go/cpc.37">http://www.hp.com/go/cpc.37</a>

37. HP Care Packs are sold separately. Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. For details, visit http://www.hp.com/go/cpc. HP services are governed by the applicable HP terms and conditions of service provided or indicated to Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product.



## **Technical Specifications**

#### **ENVIRONMENTAL & INDUSTRY**

Eco-Label Certifications & declarations	This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:			
	•IT ECO declaration			
	•US ENERGY STAR®			
	•EPEAT® 2019 Gold in U.S. Based o	_	_	
	EPEAT®. EPEAT® status varies by co	ountry. Visit http://www.epeat.ne	et for more information.	
System Configuration	The configuration used for the Energy Consumption and Declared Noise Emissions data for Notebook model is based on a "Typically Configured Notebook".			
Energy Consumption (in accordance with US ENERGY STAR® test method)	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz	
Normal Operation	4.14 W	4.164 W	4.056 W	
(Short idle)				
Normal Operation (Long idle)	2.112 W	2.184 W	2.076 W	
Sleep	0.372 W	0.384 W	0.372 W	
Off	0.192 W	0.228 W	0.192 W	
Heat Dissipation*	Microsoft Windows® operating sys	230VAC, 50Hz	100VAC, 50Hz	
Normal Operation	14 BTU/hr	14 BTU/hr	14 BTU/hr	
(Short idle)				
Normal Operation (Long idle)	7 BTU/hr	7 BTU/hr	7 BTU/hr	
Sleep	1 BTU/hr	1 BTU/hr	1 BTU/hr	
Off	1 BTU/hr	1 BTU/hr 1 BTU/hr		
	Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.			
Declared Noise	Sound Power		ing the service tever is attained	
Emissions			Sound Pressure	
(in accordance with	(L <sub>WAd</sub> , bels)		Sound Pressure	
ISO 7779 and ISO 9296)	(L <sub>WAd</sub> , bels)		Sound Pressure (L <sub>pAm</sub> , decibels)	
ISO 7779 and ISO 9296) Typically Configured –	(L <sub>WAd</sub> , bels)		Sound Pressure	
ISO 7779 and ISO 9296) Typically Configured — Idle Fixed Disk — Random writes			Sound Pressure (L <sub>pAm</sub> , decibels)	



	• Formaldehyde		
	Chlorinated Paraffins     Toward debudge		
	<ul> <li>Certain Brominated Flame Retardants – may not be used as flame retardants in plastics</li> <li>Cadmium</li> <li>Chlorinated Hydrocarbons</li> </ul>		
			tardants in plactics
	to the HP General Specification for the Environment at http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf): • Asbestos • Certain Azo Colorants		
ייוםנכו ומנ טטמטכ	This product does not contain any of the following substances in excess of regulatory limits (refer		
Material Usage	PLASTIC/Polyethylene low density - LDPE		9 g
	Internal:	PLASTIC/Polyethylene Expanded - EPE	31 g
	Internal	-	
		PAPER/Corrugated	230 g
Packaging Materials	External:	PAPER/Paper	51 g
	• This product contains 2.4% post-consumer recycled plastic (by wt.) • This product is 96.2% recycle-able when properly disposed of at end of life.		
	<ul> <li>Plastics parts weighing over 25 grams used in the product are marked per ISO11469 and ISO1043.</li> <li>This product contains 2.4% post-consumer recycled plastic (by wt.)</li> </ul>		
	http://www.epeat.net  • Plactics parts weighing over 25 grams used in the product are marked per ISO11469 and ISO1043		
	This product is in compliance with the IEEE 1680.1 (EPEAT) standard at the <gold> level, see     http://www.opeat.net</gold>		
	• This product is in compliance with California Proposition 65 (State of California; Safe Drinking W and Toxic Enforcement Act of 1986).		
	Directive – 2		alifornia: Cafo Drinking Water
	-	oduct is designed to comply with the Waste Electrical and	Electronic Equipment (WEEE)
	2011/65/EC		
• This product is in compliance with the Restrictions of Hazardous Substance			ubstances (RoHS) directive -
	Battery type: Not Applicable		
	Battery size: Not Applicable		
	Cadmium greater than 20ppm by weight		
		ater the1ppm by weight	
	Batteries used in the product do not contain:		
Batteries	production.  This battery(s) in this product comply with EU Directive 2006/66/EC		
	Spare parts are available throughout the warranty period and or for up to "5" years after the end		
			. I. 457
	• 1 multi-bay II storage port		
	Optional expansion base docking station		
	• 2 SODIMM memory slots		
	• 1 ExpressCard/54 slot • 1 IEEE 1394 Port		
		ard/F4 clot	



•	- Hala sanatad Diahamul Mathamas		
	Halogenated Diphenyl Methanes     Lead carbonates and sulfates		
	Lead and Lead compounds		
	Mercuric Oxide Batteries		
	Nickel – finishes must not be used on the external surface designed to be frequently handled or     carried by the user.		
	carried by the user.		
	Ozone Depleting Substances     Ozone Depleting Substances		
	Polybrominated Biphenyls (PBBs)		
	Polybrominated Biphenyl Ethers (PBBEs)		
	Polybrominated Biphenyl Oxides (PBBOs)     Polybrominated Biphenyl (PCR)		
	Polychlorinated Biphenyl (PCB)     A second se		
	Polychlorinated Terphenyls (PCT)		
	• Polyvinyl Chloride (PVC) — except for wires and cables, and certain retail packaging has bee		
	voluntarily removed from most applications.		
	Radioactive Substances		
	• Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)		
Packaging Usage	HP follows these guidelines to decrease the environmental impact of product packaging:		
	• Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging		
	materials.		
• Eliminate the use of ozone-depleting substances (ODS) in packaging materials.			
	Design packaging materials for ease of disassembly.		
	Maximize the use of post-consumer recycled content materials in packaging materials.		
	Use readily recyclable packaging materials such as paper and corrugated materials.		
	Reduce size and weight of packages to improve transportation fuel efficiency.		
	• Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.		
End-of-life Management and Recycling	HP Inc. offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/go/reuse-recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.		
	The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for		
	each product type for use by treatment facilities. This information (product disassembly		
	instructions) is posted on the Hewlett Packard web site at: http://www.hp.com/go/recyclers. These		
	instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM		
	customers who integrate and re-sell HP equipment.		
	castomers who integrate and re-search equipments		
HP Inc. Corporate	For more information about HP's commitment to the environment:		
Environmental	Global Citizenship Report		
Information	http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html		
	Eco-label certifications		
	http://www8.hp.com/us/en/hp-information/environment/ecolabels.html		
	ISO 14001 certificates:		



http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/PC_GBU_Product_Design_ISO_14K _Certificate.pdf
and
http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf



### **Technical Specifications**

#### **SYSTEM UNIT**

Stand-Alone Power Requirements (AC Power)

Nominal Operating Voltage 19 V
Average Operating Power 4.62 W
Integrated graphics Yes

Max Operating Power UMA < 45W

**Temperature** 

Operating 32° to 95° F (0° to 35° C) Non-operating -4° to 140° F (-20° to 60° C)

**Relative Humidity** 

Operating 10% to 90%, non-condensing

Non-operating 5% to 95%, 101.6° F (38.7° C) maximum wet bulb temperature

Shock

Operating 40 G, 2 ms, half-sine Non-operating 200 G, 2 ms, half-sine

**Random Vibration** 

Operating 0.75 grms
Non-operating 1.50 grms

**Altitude (unpressurized)** 

Operating -50 to 10,000 ft (-15.24 to 3,048 m)

Non-operating -50 to 40,000 ft (-15.24 to 12,192 m)

**Planned Industry Standard Certifications** 

UL Yes
CSA Yes
FCC Compliance Yes

ENERGY STAR® Select models 38

EPEAT® 2019 Gold in U.S. 39

**ICES** Yes Australia / Yes Yes NZ A – Tick Compliance CCC Yes Japan VCCI Compliance Yes KC Yes **BSMI** Yes **CE Marketing Compliance** Yes **BNCI or BELUS** Yes CIT Yes GOST Yes Saudi Arabian Compliance (ICCP) Yes SABS Yes

38.Configurations of the HP ProBook 430 G8 that are ENERGY STAR® certified are identified as HP ProBook 430 G8 ENERGY STAR on HP websites and on http://www.energystar.gov.



### **Technical Specifications**

39. Based on US EPEAT® registration according to IEEE 1680.1-2018 EPEAT®. EPEAT® status varies by country. Visit http://www.epeat.net for more information.

#### **DISPLAYS**

Note: All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower.

Actual brightness will be lower with touchscreen or Sure View.

Panel LCD 13.3 inch FHD (1920x1080) Anti-Glare WLED UWVA 45% NTSC 250nits eDP 1.2 w/o PSR slim NWBZ Outline Dimensions (W x H x D) 300.56 x 187.77 mm (max) (w/ PCB & w/o bracket)

**Active Area** 293.76 x 165.24 mm (typ.)

Weight 260 g (max)

Diagonal Size 13.3 inch

Thickness 3.0 mm (max)

Interface eDP 1.2 (2 lane)

Surface Treatment Anti-Glare

Touch Enabled No

Contrast Ratio600:1 (typ.)Refresh Rate60 Hz

Brightness250nits (typ.)Pixel Resolution1920 x 1080 (FHD)

Format RGB

Backlight LED

Color Gamut Coverage NTSC 45%

Color Depth 6 bits

Viewing Angle UWVA 85/85/85

Panel LCD 13.3 inch FHD (1920x1080) Anti-Glare WLED UWVA 45% NTSC 250nits eDP slim Touch on Panel NWBZ 

 Outline Dimensions (W x H x D)
 300.56 x 177.77 mm (max)

 Active Area
 293.76 x 165.24 mm (typ.)

Weight 260 g (max)
Diagonal Size 13.3 inch

Thickness 3.0 mm/ 5.0 mm (PCB) (max)

Interface eDP 1.2

Surface Treatment Anti-Glare On-cell

Touch Enabled Yes

Contrast Ratio600:1 (typ.)Refresh Rate60 HzBrightness250 nits

Pixel Resolution 1920 x 1080 (FHD)

Format RGB Stripe
Backlight LED
Color Gamut Coverage NTSC 45%

**Color Depth** 6 bits (Hi FRC supportive w/ condition to enable)



### **Technical Specifications**

Viewing Angle UWVA 85/85/85

Panel LCD 13.3 inch FHD (1920x1080) Anti-Glare WLED UWVA 72% NTSC 1000nits eDP 1.4+PSR2 flat Privacy NWBZ Gen3 

 Outline Dimensions (W x H x D)
 299.06 x 186.54 mm (max)

 Active Area
 293.76 x 165.24 mm (typ.)

Weight255 g (max)Diagonal Size13.3 inchThickness3.0 mm (max)

Interface eDP 1.4 + PSR (4 lane)
Surface Treatment Anti-Glare (AG)

Touch Enabled No

Contrast Ratio2000:1 (typ.)Refresh Rate60 HzBrightness1000 nits

Pixel Resolution 1920 x 1080 (FHD)

Format RGB Backlight LED

**Color Gamut Coverage** sRGB 100% **Color Depth** 8 bits

Viewing Angle UWVA 85/85/85

Panel LCD 13.3 inch FHD (1920x1080) Anti-Glare WLED UWVA 72% NTSC 400nits eDP 1.4+PSR2 ultraslim LP NWBZ 

 Outline Dimensions (W x H x D)
 299.06 x 185.54 mm (max)

 Active Area
 293.76 x 165.24 mm (typ.)

Weight 170 g (max)

Diagonal Size 13.3 inch

Thickness 2.0 mm (max)

Interface eDP 1.4 + PSR2 (2 lane)

**Surface Treatment** Anti-Glare

Touch Enabled No

Contrast Ratio 1200:1 (typ.)

**Refresh Rate** 60 Hz **Brightness** 400 nits

Pixel Resolution 1920 x 1080 (FHD)

Format RGB
Backlight LED
Color Gamut Coverage NTSC 72%

Color Depth 8 bits

Viewing Angle UWVA 85/85/85



### **Technical Specifications**

Panel LCD 13.3 inch HD (1366x768) Anti-Glare WLED SVA 45% NTSC 250nits eDP NWBZ ultraslim Outline Dimensions (W x H x D) 300.56 x 187.77 max. (w/ PCB & w/o bracket)

**Active Area** 293.83 x 165.20 typ

Weight 260g Max
Diagonal Size 13.3 inch
Thickness 3.0 mm max.
Interface eDP 1.2 (1 lane)
Surface Treatment Anti-Glare

**Touch Enabled** No

Contrast Ratio300:1 (typ)Refresh Rate60 HzBrightness250 nits

Pixel Resolution 1366 x 768 (HD)

Format RGB

Backlight LED

Color Gamut Coverage NTSC 45%

Color Depth 6 bits

Viewing Angle SVA 45/45/15/35



## **Technical Specifications**

#### **STORAGE AND DRIVES\***

\*For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10) is reserved for system recovery software.

SSD 128GB 2280 PCIe-3x2 Three Layer Cell

Form Factor M.2 2280
Capacity 128 GB
NAND Type TLC

Height 0.09 in (2.3 mm)
Width 0.87 in (22 mm)
Weight 0.02 lb (10 g)
Interface PCIe NVMe

Maximum Sequential Read 1400 ~ 2100 MB/s

Maximum Sequential Write 800 ~ 1200 MB/s

Logical Blocks 250,069,680

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]
Features ATA Security; DIPM; TRIM; DEVSLP

0.09 in (2.3 mm)

SSD 1TB 2280 PCIe-3x4 NVMe Three Layer Cell single-sided Form Factor M.2 2280
Capacity 1 TB
NAND Type TLC

Height

Width 0.87 in (22 mm)

Weight 0.02 lb (10 g)

Interface PCIe NVMe Gen3X4

Maximum Sequential Read 3100 ~ 3500 MB/s

Maximum Sequential Write 2770 ~ 3037 MB/s

Logical Blocks 2,000,409,264

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features ATA Security; TRIM; L1.2

SSD 256GB 2280 PCIe NVMe Form Factor Value

Form Factor M.2 2280
Capacity 256 GB
NAND Type Value

Height 0.09 in (2.3 mm)

Width 0.87 in (22 mm)

Weight 0.02 lb (10 g)

Interface PCIe NVMe Gen3

Maximum Sequential Read 2100 ~ 2200 MB/s

Maximum Sequential Write 900 ~ 1400 MB/s



### **Technical Specifications**

Logical Blocks 500,118,192

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]
Features ATA Security (optional); TRIM; L1.2

#### SSD 512GB 2280 PCIe NVMe

Value

Form Factor M.2 2280
Capacity 512 GB
NAND Type Value

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Weight
 0.02 lb (10 g)

 Interface
 PCIe NVMe Gen3

 Maximum Sequential Read
 2200 ~ 2300 MB/s

 Maximum Sequential Write
 1000 ~ 1600 MB/s

 Logical Blocks
 1,000,215,215

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]
Features ATA Security (optional); TRIM; L1.2

#### SSD 512GB 2280 PCIe-3x2x2 NVMe+SSD 32GB 3D Xpoint

Form Factor M.2 2280 Capacity 512 GB

NAND Type QLC+3D XPoint
Height 0.09 in (2.3 mm)
Width 0.87 in (22 mm)
Weight 0.02 lb (10 g)

Interface PCIe NVMe Gen3X2X2

Maximum Sequential Read Up to 2400 MB/s

Maximum Sequential Write Up to 1300 MB/s

Logical Blocks 1,000,215,215

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features ATA Security; TRIM; L1.2



#### **NETWORKING/COMMUNICATIONS**

Intel Wi-Fi<sup>®</sup> 6<sup>1</sup> AX201 + Bluetooth<sup>®</sup> 5.1 (802.11ax

Eluetootn® 5.1 (802.11a 2x2. non-vPro®.

supporting gigabit file transfer speeds)<sup>5</sup>

non-vPro®

**Wireless LAN Standards** 

IEEE 802.11a IEEE 802.11b

IEEE 802.11g

IEEE 802.11n

IEEE 802.11ac

IEEE 802.11ax

LLL 002.11a/

IEEE 802.11d

IEEE 802.11e

IEEE 802.11h

IEEE 802.11i

IEEE 802.11k IEEE 802.11r

IEEE 802.11v

Interoperability

Features Wi-Fi®® 6 technology

Frequency Band • 802.11b/g/n/ax

2.402 - 2.482 GHz

• 802.11a/n/ac/ax

4.9 - 4.95 GHz (Japan)

5.15 – 5.25 GHz

5.25 – 5.35 GHz 5.47 – 5.725 GHz

5.825 - 5.850 GHz

**Data Rates** 

• 802.11b: 1, 2, 5.5, 11 Mbps

• 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps

• 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps

802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)

802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, 80MHz &

160MHz)

• 802.11ax: MCS0 ~ MCS11, (1SS and 2SS) (20MHz, 40MHz, 80MHz &

160MHz)

Modulation

**Direct Sequence Spread Spectrum** 

OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM, 1024QAM

Security<sup>3</sup>

• IEEE compliant 64 / 128-bit WEP encryption for a/b/g mode only

• AES-CCMP: 128 bit in hardware

• 802.1x authentication

• WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

WPA2 certification

• WPA3 certification

• IEEE 802.11i

WAPI

**Network Architecture** 

Models

Ad-hoc (Peer to Peer)

Infrastructure (Access Point Required)

Roaming

IEEE 802.11 compliant roaming between access points

Output Power<sup>2</sup>

• 802.11b: +18.5dBm minimum

• 802.11g: +17.5dBm minimum



• 802.11a: +18.5dBm minimum

802.11n HT20(2.4GHz): +15.5dBm minimum
802.11n HT40(2.4GHz): +14.5dBm minimum
802.11n HT20(5GHz): +15.5dBm minimum
802.11n HT40(5GHz): +14.5dBm minimum
802.11ac VHT80(5GHz): +11.5dBm minimum

802.11ac VHT160(5GHz): +11.5dBm minimum
 802.11ax HT40(2.4GHz): +10dBm minimum
 802.11ax VHT160(5GHz): +10dBm minimum

**Power Consumption** 

• Transmit mode: 2.0 W

• Receive mode:1.6 W

Idle mode (PSP) 180 mW (WLAN Associated)
 Idle mode: 50 mW (WLAN unassociated)
 Connected Standby/Modern Standby: 10mW

• Radio disabled: 8 mW

**Power Management** 

ACPI and PCI Express compliant power management 802.11 compliant

power saving mode

Receiver Sensitivity<sup>3</sup>

802.11b, 1Mbps: -93.5dBm maximum
802.11b, 11Mbps: -84dBm maximum
802.11a/g, 6Mbps: -86dBm maximum
802.11a/g, 54Mbps: -72dBm maximum
802.11n, MCS07: -67dBm maximum
802.11n, MCS15: -64dBm maximum

802.11ac, MCS0: -84dBm maximum
802.11ac, MCS9: -59dBm maximum
802.11ax, MCS11(HT40): -59dBm maximum

• 802.11ax, MCS11(HT40): -59.5dBm maximum

Antenna type

High efficiency antenna with spatial diversity, mounted in the display

enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications

Form Factor PCI-Express M.2 MiniCard with CNVi Interface

**Dimensions** 1. Type 2230: 2.3 x 22.0 x 30.0 mm

2. Type 1216: 1.67 x 12.0 x 16.0 mm

**Weight** 1. Type 2230: 2.8 g

2. Type 126: 1.3 g

**Operating Voltage** 3.3v +/- 9%

**Temperature** Operating 14° to 158° F (-10° to 70° C)

**Non-operating**  $-40^{\circ}$  to  $176^{\circ}$  F ( $-40^{\circ}$  to  $80^{\circ}$  C)

**Humidity** Operating 10% to 90% (non-condensing)

**Non-operating** 5% to 95% (non-condensing)

**Altitude Operating** 0 to 10,000 ft (3,048 m)

**Non-operating** 0 to 50,000 ft (15,240 m)

**LED Activity** LED Amber – Radio OFF

LED Off - Radio ON



### **Technical Specifications**

#### HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0/5.1 Wireless Technology

Bluetooth Specification 4.0/4.1/4.2/5.0/5.1 Compliant

Frequency Band 2402 to 2480 MHz

**Number of Available** 

Channels

Legacy: 0~79 (1 MHz/CH) BLE: 0~39 (2 MHz/CH)

**Signaling Data Rate** Legacy: 3 Mbps signaling data rate\* 2.17 Mbps

BLE: 1 Mbps signaling data rate\* 0.2 Mbps

\* Actual throughput may vary.

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice

channels

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

**Transmit Power** The Bluetooth component shall operate as a Class II Bluetooth device with

a maximum transmit power of + 9.5 dBm for BR and EDR.

ETS 300 328, ETS 300 826Low Voltage Directive IEC950

Power Consumption Peak (Tx) 330 mWPeak (Rx) 230 mW

Selective Suspend 17 mW

**Bluetooth Software** 

Supported Link Topology Microsoft Windows Bluetooth Software

**Power Management** Microsoft Windows ACPI, and USB Bus Support **Certifications** FCC (47 CFR) Part 15C, Section 15.247 & 15.249

Power Management

Certifications

UL, CSA, and CE Mark

BT4.1-ESR 5/6/7 Compliance

Bluetooth Profiles

**Supported** LE Link Layer Ping

LE Dual Mode LE Link Laver

LE Low Duty Cycle Directed Advertising
LE L2CAP Connection Oriented Channels

Train Nudging & Interlaced Scan

BT4.2 ESR08 Compliance

LE Secure Connection- Basic/Full LE Privacy 1.2 —Link Layer Privacy

LE Privacy 1.2 - Extended Scanner Filter Policies

LE Data Packet Length Extension

FAX Profile (FAX)

Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP)

Advanced Audio Distribution Profile (A2DP)

1. Wireless access point and Internet service required and sold separately. Availability of public wireless access points limited. The specifications for Wi-Fi® 6 (802.11ax WLAN) are draft specifications and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the notebook to communicate with other 802.11ax WLAN devices. Only available in countries where 802.11ax is supported.



- 2. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.
- 3. Check latest software/driver release for updates on supported security features.
- 4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/q (OFDM modulation).
- 5. Wi-Fi® supporting gigabit speeds is achievable when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 160MHz channels.



Intel Jefferson Peak2 9560 802.11a/b/g/n/ac (2x2) WiFi® and

Bluetooth® 5.0 Combo¹

non-vPro®

Wireless LAN Standards IEEE 802.11a

IEEE 802.11b IEEE 802.11g

IEEE 802.11n IEEE 802.11ac IEEE 802.11d IEEE 802.11e IEEE 802.11h

IEEE 802.11i IEEE 802.11k IEEE 802.11r IEEE 802.11v

Interoperability Wi-Fi®® CERTIFIED modules

Frequency Band • 802.11b/g/n

2.402 – 2.482 GHz • 802.11a/n/ac

4.9 – 4.95 GHz (Japan) 5.15 – 5.25 GHz 5.25 – 5.35 GHz 5.47 – 5.725 GHz 5.825 – 5.850 GHz

**Data Rates** • 802.11b: 1, 2, 5.5, 11 Mbps

802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)

• 802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, 80MHz &

160MHz)

**Modulation** Direct Sequence Spread Spectrum

BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM

• IEEE and WiFi® compliant 64 / 128-bit WEP encryption for a/b/g mode

only

AES-CCMP: 128 bit in hardware

• 802.1x authentication

• WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

WPA2 certificationWPA3 certificationIEEE 802.11iWAPI

Network Architecture

Models

Ad-hoc (Peer to Peer)

Infrastructure (Access Point Required)

**Roaming** IEEE 802.11 compliant roaming between access points

Output Power<sup>2</sup> • 802.11b: +18.5dBm minimum

• 802.11g: +17.5dBm minimum • 802.11a: +18.5dBm minimum

802.11n HT20(2.4GHz): +15.5dBm minimum
802.11n HT40(2.4GHz): +14.5dBm minimum



802.11n HT20(5GHz): +15.5dBm minimum
802.11n HT40(5GHz): +14.5dBm minimum
802.11ac VHT80(5GHz): +11.5dBm minimum

• 802.11ac VHT160(5GHz): +11.5dBm minimum

**Power Consumption** • Transmit mode: 2.0 W

• Receive mode:1.6 W

Idle mode (PSP) 180 mW (WLAN Associated)
Idle mode: 50 mW (WLAN unassociated)
Connected Standby/Modern Standby: 10mW

• Radio disabled: 8 mW

**Power Management** ACPI and PCI Express compliant power management

802.11 compliant power saving mode

**Receiver Sensitivity**<sup>4</sup> • 802.11b, 1Mbps: -93.5dBm maximum

802.11b, 11Mbps: -84dBm maximum
802.11a/g, 6Mbps: -86dBm maximum
802.11a/g, 54Mbps: -72dBm maximum
802.11n, MCS07: -67dBm maximum
802.11n, MCS15: -64dBm maximum
802.11ac, MCS0: -84dBm maximum

• 802.11ac, MCS9: -59dBm maximum

Antenna type High efficiency antenna with spatial diversity, mounted in the display

enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications

Form Factor PCI-Express M.2 MiniCard with CNVi Interface

**Dimensions** 1. Type 2230: 2.3 x 22.0 x 30.0 mm

2. Type 1216: 1.67 x 12.0 x 16.0 mm

**Weight** 1. Type 2230: 2.8 g

2. Type 126: 1.3 g

Operating Voltage 3.3v +/- 9%

**Temperature Operating** 14° to 158° F (–10° to 70° C)

**Non-operating**  $-40^{\circ}$  to  $176^{\circ}$  F ( $-40^{\circ}$  to  $80^{\circ}$  C)

**Humidity** Operating 10% to 90% (non-condensing)

**Non-operating** 5% to 95% (non-condensing)

**Operating** 0 to 10,000 ft (3,048 m)

**Non-operating** 0 to 50,000 ft (15,240 m)

**LED Activity** LED Amber – Radio OFF

LED Off - Radio ON

HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0 Wireless Technology

**Bluetooth Specification** 4.0/4.1/4.2/5.0 Compliant

Frequency Band 2402 to 2480 MHz

Number of Available Legacy: 0~79 (1 MHz/CH)
Channels BLE: 0~39 (2 MHz/CH)



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BLE: 1 Mbps signaling data rate\* throughput up to 0.2 Mbps

\* Actual throughput may vary.

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice

channels

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

**Transmit Power** The Bluetooth component shall operate as a Class II Bluetooth device with

a maximum transmit power of + 4 dBm for BR and EDR.

Power Consumption Peak (Tx) 330 mWPeak (Rx) 230 mW

Selective Suspend 17 mW

**Bluetooth Software** 

Supported Link Topology Microsoft Windows Bluetooth Software

**Power Management** Microsoft Windows ACPI, and USB Bus Support **Certifications** FCC (47 CFR) Part 15C, Section 15.247 & 15.249

Power Management Certifications

ETS 300 328, ETS 300 826Low Voltage Directive IEC950

fications UL, CSA, and CE Mark

Bluetooth Profiles
Supported

BT4.1-ESR 5/6/7 Compliance

LE Link Layer Ping LE Dual Mode LE Link Layer

LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels

Train Nudging & Interlaced Scan

BT4.2 ESR08 Compliance

LE Secure Connection- Basic/Full LE Privacy 1.2 -Link Layer Privacy

LE Privacy 1.2 - Extended Scanner Filter Policies

LE Data Packet Length Extension

FAX Profile (FAX)

Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP)

Advanced Audio Distribution Profile (A2DP)

- 1. Wireless access point and internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi® 6 is backwards compatible with prior 802.11 specs. The specifications for Wi-Fi® 6 (802.11ax) are draft and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the notebook to communicate with other 802.11ax devices. Only available in countries where 802.11ax is supported. Wi-Fi® supporting gigabit speeds is achievable when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 160 MHz channels.
- 2. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.
- 3. Check latest software/driver release for updates on supported security features.
- 4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).



## **Technical Specifications**

Realtek RTL8822CE 802.11ac 2x2 Wi-Fi® + Bluetooth® 5.0 Wireless LAN Standards IEEE 802.11a

IEEE 802.11b IEEE 802.11g

IEEE 802.11n
IEEE 802.11ac
IEEE 802.11d
IEEE 802.11e
IEEE 802.11h
IEEE 802.11i
IEEE 802.11k
IEEE 802.11r

IEEE 802.11v

Interoperability Wi-Fi®® CERTIFIED modules

Frequency Band • 802.11b/g/n

2.402 – 2.482 GHz • 802.11a/n/ac

4.9 – 4.95 GHz (Japan) 5.15 – 5.25 GHz 5.25 – 5.35 GHz 5.47 – 5.725 GHz 5.825 – 5.850 GHz

**Data Rates** • 802.11b: 1, 2, 5.5, 11 Mbps

802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)

• 802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, 80MHz &

160MHz)

**Modulation** Direct Sequence Spread Spectrum

BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM

• IEEE and WiFi® compliant 64 / 128-bit WEP encryption for a/b/g mode

only

• AES-CCMP: 128 bit in hardware

• 802.1x authentication

• WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

WPA2 certificationWPA3 certificationIEEE 802.11iWAPI

**Network Architecture** 

Models

Ad-hoc (Peer to Peer)

Infrastructure (Access Point Required)

**Roaming** IEEE 802.11 compliant roaming between access points

Output Power<sup>2</sup> • 802.11b: +18.5dBm minimum

802.11g: +17.5dBm minimum802.11a: +18.5dBm minimum

802.11n HT20(2.4GHz): +15.5dBm minimum
 802.11n HT40(2.4GHz): +14.5dBm minimum



802.11n HT20(5GHz): +15.5dBm minimum
802.11n HT40(5GHz): +14.5dBm minimum
802.11ac VHT80(5GHz): +11.5dBm minimum

• 802.11ac VHT160(5GHz): +11.5dBm minimum

Power Consumption • Transmit mode: 2.0 W

• Receive mode:1.6 W

Idle mode (PSP) 180 mW (WLAN Associated)
Idle mode: 50 mW (WLAN unassociated)
Connected Standby/Modern Standby: 10mW

• Radio disabled: 8 mW

**Power Management** ACPI and PCI Express compliant power management

802.11 compliant power saving mode

**Receiver Sensitivity**<sup>4</sup> • 802.11b, 1Mbps: -93.5dBm maximum

802.11b, 11Mbps: -84dBm maximum
802.11a/g, 6Mbps: -86dBm maximum
802.11a/g, 54Mbps: -72dBm maximum
802.11n, MCS07: -67dBm maximum
802.11n, MCS15: -64dBm maximum

802.11ac, MCS0: -84dBm maximum
802.11ac, MCS9: -59dBm maximum

Antenna type High efficiency antenna with spatial diversity, mounted in the display

enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications

Form Factor PCI-Express M.2 MiniCard

**Dimensions** 1. Type 2230: 2.3 x 22.0 x 30.0 mm

2. Type 1216: 1.67 x 12.0 x 16.0 mm

**Weight** 1. Type 2230: 2.8 g

2. Type 126: 1.3 g

Operating Voltage 3.3v +/- 9%

**Temperature Operating** 14° to 158° F (–10° to 70° C)

**Non-operating**  $-40^{\circ}$  to  $176^{\circ}$  F ( $-40^{\circ}$  to  $80^{\circ}$  C)

**Humidity** Operating 10% to 90% (non-condensing)

**Non-operating** 5% to 95% (non-condensing)

**Altitude Operating** 0 to 10,000 ft (3,048 m)

**Non-operating** 0 to 50,000 ft (15,240 m)

**LED Activity** LED Amber – Radio OFF

LED Off – Radio ON

HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0 Wireless Technology

**Bluetooth Specification** 4.0/4.1/4.2/5.0 Compliant

Frequency Band 2402 to 2480 MHz

Number of Available Legacy: 0~79 (1 MHz/CH)
Channels BLE: 0~39 (2 MHz/CH)



**Signaling Data Rate** Legacy: 3 Mbps signaling data rate\* throughput up to 2.17 Mbps

BLE: 1 Mbps signaling data rate\* throughput up to 0.2 Mbps

\* Actual throughput may vary.

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice

channels

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

**Transmit Power** The Bluetooth component shall operate as a Class II Bluetooth device with

a maximum transmit power of + 4 dBm for BR and EDR.

Power Consumption Peak (Tx) 330 mWPeak (Rx) 230 mW

Selective Suspend 17 mW

**Bluetooth Software** 

Supported Link Topology Microsoft Windows Bluetooth Software

**Power Management** Microsoft Windows ACPI, and USB Bus Support **Certifications** FCC (47 CFR) Part 15C, Section 15.247 & 15.249

Power Management Certifications

ETS 300 328, ETS 300 826Low Voltage Directive IEC950

UL, CSA, and CE Mark

Bluetooth Profiles
Supported

BT4.1-ESR 5/6/7 Compliance

LE Link Layer Ping LE Dual Mode LE Link Layer

LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels

Train Nudging & Interlaced Scan

BT4.2 ESR08 Compliance

LE Secure Connection- Basic/Full LE Privacy 1.2 -Link Layer Privacy

LE Privacy 1.2 - Extended Scanner Filter Policies

LE Data Packet Length Extension

FAX Profile (FAX)

Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP)

Advanced Audio Distribution Profile (A2DP)

- 1. Wireless access point and internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi® 6 is backwards compatible with prior 802.11 specs. The specifications for Wi-Fi® 6 (802.11ax) are draft and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the notebook to communicate with other 802.11ax devices. Only available in countries where 802.11ax is supported. Wi-Fi® supporting gigabit speeds is achievable when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 160 MHz channels.
- 2. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.
- 3. Check latest software/driver release for updates on supported security features.
- 4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).



## **Technical Specifications**

Realtek RTL8852AE 802.11ax¹ 2x2 Wi-Fi® + Bluetooth®5.2 (802.11ax 2x2, supporting gigabit data rate) <sup>5</sup>

Wireless LAN Standards IEEE 802.11a

IEEE 802.11b

IEEE 802.11n

IEEE 802.11ac

IEEE 802.11ax

IEEE 802.11d

IEEE 802.11e

IEEE 802.11h

IEEE 802.11i

IEEE 802.11k IEEE 802.11r

IEEE 802.11v

Interoperability

Wi-Fi® certified modules

Frequency Band •802.11b/g/n/ax

2.402 - 2.482 GHz

•802.11a/n/ac/ax

4.9 - 4.95 GHz (Japan)

5.15 – 5.25 GHz

5.25 – 5.35 GHz 5.47 – 5.725 GHz

5.825 – 5.850 GHz

Data Rates

• 802.11b: 1, 2, 5.5, 11 Mbps

• 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps

• 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps

• 802.11n: max 300Mbps

• 802.11ac : max 866.7Mbps

802.11ax: max 1201Mbps

Modulation

**Direct Sequence Spread Spectrum** 

BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM, 1024QAM

Security<sup>3</sup>

• IEEE and WiFi certified 64 / 128 bit WEP encryption for a/b/g mode only

AES-CCMP: 128 bit in hardware

• 802.1x authentication

• WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

WPA2 certification

WPA3 certification

• IEEE 802.11i

WAPI

**Network Architecture** 

Models

Ad-hoc (Peer to Peer)

Infrastructure (Access Point Required)

Roaming

IEEE 802.11 compliant roaming between access points

Output Power<sup>2</sup>

• 802.11b: +18.5dBm minimum

• 802.11g: +17.5dBm minimum

• 802.11a: +18.5dBm minimum

• 802.11n HT20(2.4GHz): +15.5dBm minimum

• 802.11n HT40(2.4GHz): +14.5dBm minimum



• 802.11n HT20(5GHz): +15.5dBm minimum • 802.11n HT40(5GHz): +14.5dBm minimum • 802.11ac VHT80(5GHz): +11.5dBm minimum • 802.11ax HE40(2.4GHz): +10dBm minimum

• 802.11ax HE80(5GHz): +10dBm minimum

Power Consumption • Transmit mode: 2.5 W

• Receive mode: 2 W

• Idle mode (PSP) 180 mW (WLAN Associated) Idle mode:50 mW (WLAN unassociated) Connected Standby/Modern Standby: 10mW

Radio disabled: 8 mW

**Power Management** ACPI and PCI Express compliant power management

802.11 compliant power saving mode

Receiver Sensitivity<sup>4</sup> •802.11b, 1Mbps: -93.5dBm maximum

> •802.11b, 11Mbps: -84dBm maximum •802.11a/q, 6Mbps: -86dBm maximum •802.11a/q, 54Mbps: -72dBm maximum •802.11n, MCS07: -67dBm maximum •802.11n, MCS15: -64dBm maximum •802.11ac, MCS0: -84dBm maximum •802.11ac, MCS9: -59dBm maximum

•802.11ax, MCS11(HE40): -57dBm maximum •802.11ax, MCS11(HE80): -54dBm maximum

Antenna type High efficiency antenna with spatial diversity, mounted in the display

enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications

**Form Factor** PCI-Express M.2 MiniCard

**Dimensions** 1. Type 2230: 2.3 x 22.0 x 30.0 mm

2. Type 1216: 1.67 x 12.0 x 16.0 mm

Weight 1. Type 2230: 2.8q

2. Type 126: 1.3g

**Operating Voltage** 3.3v +/- 9%

**Temperature** Operating 14° to 158° F (-10° to 70° C)

> Non-operating -40° to 176° F (-40° to 80° C)

**Humidity** Operating 10% to 90% (non-condensing)

> Non-operating 5% to 95% (non-condensing)

**Altitude** Operating 0 to 10.000 ft (3.048 m)

> Non-operating 0 to 50,000 ft (15,240 m)

**LED Activity** LED Amber - Radio OFF

LED Off - Radio ON

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Channels BLE: 0~39 (2 MHz/CH)

BLE. 0~35 (2 MHZ/CF

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Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice

channels

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

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**Power Consumption** Peak (Tx): 330 mW

Peak (Rx): 230 mW

Selective Suspend: 17 mW

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Supported Link Topology Microsoft Windows Bluetooth Software

**Power Management** 

Certifications

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UL, CSA, and CE Mark

Bluetooth Profiles Supported

BT4.1-ESR 5/6/7 Compliance

LE Link Layer Ping LE Dual Mode LE Link Layer

LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels

Train Nudging & Interlaced Scan

BT4.2 ESR08 Compliance

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LE Privacy 1.2 - Extended Scanner Filter Policies

LE Data Packet Length Extension

FAX Profile (FAX)

Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP)

Advanced Audio Distribution Profile (A2DP)

BT5.1

ESR9/10 Compliance

LE Advertisement Extensions Channel Selection Algo

Limited High Duty Cycle Non-Connectable Advertising

2Mbps LE LE Long Range



- 1. Wireless access point and Internet service required and sold separately. Availability of public wireless access points limited. The specifications for Wi-Fi® 6 (802.11ax WLAN) are draft specifications and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the notebook to communicate with other 802.11ax WLAN devices. Only available in countries where 802.11ax is supported.
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- 3. Check latest software/driver release for updates on supported security features.
- 4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/q (OFDM modulation).
- 5. Wi-Fi® supporting gigabit speeds is achievable when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 160MHz channels.



#### **POWER**

AC Adapter 45 Watt nPFC Standard USB Type-C® Straight 1.8m

Dimensions (H x W x D) 94.0mm x 40.0mm x 26.5mm

Weiaht 192.5q +/-10%

Input **Input Efficiency** Average Efficiency of 25%, 50%, 75%, 100%

load condition with 115Vac/230Vac Spec:

5V: 81.5% 9V: 86.7% 12V: 87.41% 15V: 87.8%

Input frequency range 47 ~ 63 Hz

**Input AC current** Max. 1.4 A at 90 Vac

Output **Output power** 5V/15W

> 9V/27W 12V/36W 15V/45W

DC output 5V/9V/12V/15V

Hold-up time 5 ms at 115 Vac input

Connector USB Type-C®

**Environmental Design Operating** 32°F to 95°F (0° to 35°C)

temperature

Non-operating (storage) -4°F to 185°F (-20° to 85°C)

temperature

Altitude 0 to 16,400 ft (0 to 5,000 m)

Humidity 20% to 95% **Storage Humidity** 10% to 95%

**EMI and Safety** Certifications

CE Mark - full compliance with LVD and EMC directives

Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B,

FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE. MTBF - over 200,000 hours at 25°C ambient condition.

**AC Adapter 45 Watt Smart Dimensions** nPFC Standard Barrel 4.5mm Right Angle 1.8m

Weight

Input

95 x 45 x 26.8 mm 200 q +/- 10 q

**Input Efficiency** 87.74 % at 115 Vac and 88.4 % at 230Vac

> Input frequency range 47 ~ 63 Hz

**Input AC current** Max. 1.4 A at 90 Vac

Output **Output power** 45 W

> DC output 19.5 V

Hold-up time 5 ms at 115 Vac input



Output current limit <8.0A

**Connector** 4.5mm Barrel Type

**Environmental Design** Operating 32°F to 95°F (0°to 35°C)

temperature

Non-operating (storage) -4°F to 185°F (-20°to 85°C)

temperature

**Altitude** 0 to 16,400 ft (0 to 5000m)

**Humidity** 20% to 95% **Storage Humidity** 10% to 95%

EMI and Safety CE Mark - full compliance with LVD and EMC directives

**Certifications** Worldwide safety standards - IEC60950, EN60950, UL60950, Class1,

SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B,

FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE. MTBF - over 200,000 hours at 25°C ambient condition.

AC Adapter 45 Watt Smart Dimensions nPFC Standard Barrel 4.5mm Right Angle 1.8m 2prong Input

 Dimensions
 95 x 45 x 26.8 mm

 Weight
 200 q +/- 10 q

Input Input Efficiency 87.74 % at 115 Vac and 88.4 % at 230 Vac

**Input frequency range** 47 ~ 63 Hz

Input AC current Max. 1.4 A at 90 VAC

Output Output power 45 W

DC output 19.5 V

**Hold-up time** 5 ms at 115 Vac input

Output current limit <8.0A

**Connector** 4.5mm Barrel Type

Environmental Design Operating 32°F to 95°F (0°to 35°C)

temperature

Non-operating (storage) -4°F to 185°F (-20°to 85°C)

temperature

**Altitude** 0 to 16,400 ft (0 to 5000m)

Humidity 20% to 95% Storage Humidity 10% to 95%

Storage Humidity 10% to 95%

EMI and Safety CE Mark - full compliance with LVD and

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Certifications Worldwide safety standards - IEC60950, EN60950, LU 60

Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B,

FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE.
MTBF - over 200,000 hours at 25°C ambient condition.

Dimensions

90.0 x 51 x 28.5mm



**Weight** 250 g +/- 10 g

Input Input Efficiency 81.5% min at 115 Vac/ 230 Vac @ 5V/3A

86.7% min at 115 Vac/ 230Vac @ 9V/3A 88% min at 115 Vac/ 230Vac @ 12V/5A 89% min at 115 Vac/ 230Vac @ 15V/4.33A 89% min at 115 Vac/ 230Vac @ 20V/3.25A

**Input frequency range** 47 ~ 63 Hz

Input AC current 1.6 A at 90 VAC and maximum load

8.0A Max.

Output Output power 65 W

DC output 5V/9V/12V/15V/20V
Hold-up time 5 ms at 115 Vac input

AC Adapter 65 Watt nPFC Standard USB type C<sup>®</sup> Straight 1.8m

Connector USB Type C®

**Environmental Design** Operating 32°F to 95°F (0°to 35°C)

**Output current limit** 

temperature

**Non-operating (storage)** -4°F to 185°F (-20°to 85°C)

temperature

**Altitude** 0 to 16,400 ft (0 to 5000m)

Humidity20% to 95%Storage Humidity10% to 95%

EMI and Safety Certifications CE Mark - full compliance with LVD and EMC directives

Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B,

FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE.
MTBF - over 200.000 hours at 25°C ambient condition.

AC Adapter 65 Watt Smart Dimensions (H x W x D)

nPFC EM Barrel 4.5mm Weig

**Dimensions (H x W x D)** 102 x 55 x 30mm **Weight** 250g +/-10%

Input Input Efficiency 88.0 % at 115 Vac and 89.0 % at 230 Vac

Input frequency range 47 ~ 63 Hz

Input AC current Max. 1.7 A at 90 Vac

**Output Output power** 65W

DC output 19.5V

**Hold-up time** 5 ms at 115 Vac input

Output current limit <11.0A

**Connector** 4.5mm Barrel Type

**Environmental Design** Operating 32°F to 95°F (0° to 35°C)

temperature

Non-operating (storage) -4°F to 185°F (-20° to 85°C)

temperature



Altitude 0 to 16,400 ft (0 to 5,000 m)

Humidity 20% to 95% **Storage Humidity** 10% to 95%

**EMI and Safety** Certifications

CE Mark - full compliance with LVD and EMC directives

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FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE. MTBF - over 200.000 hours at 25°C ambient condition.

AC Adapter 65 Watt Smart Dimensions (H x W x D)

nPFC Standard Barrel 4.5mm Right Angle 1.8m

Weight

230g +/-10%

90 x 51 x 28.5mm

Input

**Input Efficiency** 88.0 % at 115 Vac and 89.0 % at 230 Vac

Input frequency range 47 ~ 63 Hz

**Input AC current** Max. 1.7 A at 90 Vac

Output **Output power** 65W

> DC output 19.5V

Hold-up time 5 ms at 115 Vac input

**Output current limit** <11.0A

Connector 4.5mm Barrel Type

**Environmental Design** Operating 32°F to 95°F (0° to 35°C)

temperature

temperature

Non-operating (storage) -4°F to 185°F (-20° to 85°C)

Altitude 0 to 16,400 ft (0 to 5,000 m)

**Humidity** 20% to 95% **Storage Humidity** 10% to 95%

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FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE. MTBF - over 200,000 hours at 25°C ambient condition.



## **Technical Specifications**

Battery RH 3 Cell WHr 45 Long Life -PL Fast Charge

**Dimensions (H x W x L)** 6.2 x 68.7 x 249.6mm

Weight 190g

Cells/Type 3cell Lithium-Ion Polymer cell/ 545974

Voltage 11.4 V
Amp-hour capacity 3.950Ah
Watt-hour capacity 45 Wh

Operating (Charging) 32° to 113° F (0° to 45° C)
Operating (Discharging) 14° to 122° F (-10° to 60° C)

No

**Optional Travel Battery** 

Available Warranty

hle

Based on system offering

**Country of Origin** 

China



## Options and Accessories (sold separately and availability may vary by country)

Туре	Description	Part Number
Cases	HP Business Backpack (up to 17.3")	2SC67AA
	HP Business Slim Top Load (up to 14.1")	2SC65AA
	HP Prelude Pro Recycle Backpack	1X644AA
	HP Prelude Pro Recycle Top Load	1X645AA
	HP Recycled Top Load	5KN29AA
	HP Recycled Backpack	5KN28AA
Docking	HP USB-C® Mini Dock	1PM64AA
	HP Thunderbolt Dock 120W G2	2UK37AA
	HP TB Dock G2 w/ Combo Cable	3TR87AA
	HP TB Dock 120W G2 w/Audio	3YE87AA
	HP TB Dock 120W G2 Cable	3XB94AA
	HP TB Dock G2 Combo Cable	3XB96AA
	HP TB Dock G2 Audio Module	3AQ21AA
	HP USB-C/A Universal Dock G2	5TW13AA
	HP USB-C Dock G5	5TW10AA
Input/Output	HP USB Essential Keyboard and Mouse	H6L29AA
	HP Wired Desktop 320MK Mouse & Keyboard	9SR36AA
	HP Bluetooth Travel Mouse	6SP30AA
	HP Comfort Grip Wireless Mouse	H2L63AA
	HP Wired Desktop 320M Mouse	9VA80AA
	HP USB Travel Mouse	G1K28AA
	HP Elite USB-C Hub	4WX89AA
	HP USB-C Travel Hub G2	7PJ38AA
	HP USB-C to RJ45 Adapter	V7W66AA
	HP USB-C to USB 3.0 Adapter	N2Z63AA
	HP USB-C to HDMI 2.0 Adapter	1WC36AA
	HP Stereo USB Headset	T1A67AA
	HP Stereo 3.5mm Headset	T1A66AA
Power	HP 45W Smart AC Adapter 4.5mm	H6Y88AA
	45W Smart Power Adapter 2 prong -4.5mm (Japan only)	L6F60AA
	65W Smart Power Adapter (w/ 4.5mm to 7.5mm DC dongle)	H6Y89AA
	HP 65W Slim AC Adapter	H6Y82AA
	HP 65W USB-C Slim Power Adapter	3PN48AA
	HP 45W LC USB-C Power Adapter	1MZ01AA
	HP 65W USB-C LC Power Adapter	TBD



## Options and Accessories (sold separately and availability may vary by country)

	HP Power Bank HP USB-C Notebook Power Bank	N9F71AA 3TB55AA
Memory	HP 4GB DDR4 3200 Memory HP 8GB DDR4 3200 Memory HP 16GB DDR4 3200 Memory	286H5AA 286H8AA 286J1AA
Storage	HP External USB Optical Drive	F2B56AA
Security	HP Sure Key Cable Lock HP Nano Keyed Cable Lock	6UW42AA 1AJ39AA



## **Summary of Changes**

Date of change:	Version History:		Description of change:
December 14, 2020	V1 to V2	Update	USB Information
January 17, 2021	V2 to V3	Update	Environmental Data
January 21, 2021	V3 to V4	Added	WPA3 certification in Security, Networking section
January 26, 2021	V4 to V5	Added	New processors and USB Ports
February 2, 2021	V5 to V6	Update	Noise Emissions Data
February 25, 2021	V6 to V7	Update	Xerox DocuShare offer value
April 6, 2021	V7 to V8	Removed	Interchangeable HDD
April 20, 2021	V8 to V9	Updated	Memory Section Updated
April 29, 2021	V9 to V10	Added	Realtek WLAN/Updated TPM 2.0
May 6, 2021	V10 to V11	Removed	Processors base frequency/Added HP Smart Support
May 27, 2021	V11 to V12	Updated	Micro SD Card Reader/Add HP Wolf Pro Security Edition
June 17, 2021	V12 to V13	Updated	WLAN specs from Networking/Communications section
July 6, 2021	V13 to V14	Added	Battery dislcaimer

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